Chapter 8 - Tapeout

Course authors (Git file)



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Section 1

Open-source Tapeout informations from IHP



Open-source Tapeout informations from IHP

This chapter provides information about the Tapeout at IHP. Please follow the links to tag along with the chapter.



IHP - Repositories structure

- The designs for the open-source Tapeouts are collected as the "Open DesignLib".
- During the process of each Tapeout there are dedicated repositories by the names TO_monthyear.
- After Tapeout these designs shall be merged into the Open DesignLib repository.



PDK and Open DesignLib

Open.source PDK:

https://github.com/IHP-GmbH/IHP-Open-PDK

• Open DesignLib:

https://github.com/IHP-GmbH/IHP-Open-DesignLib



TapeOut repositories (TO)

Tapeout May 2024:

https://github.com/IHP-GmbH/TO_May2024

• Tapeout Nov 2024:

https://github.com/IHP-GmbH/TO_Nov2024

Tapeout Dec 2024:

https://github.com/IHP-GmbH/TO_Dec2024



Section 2

READMEs



README file in TO repositories

Important notes:

- Always look for the most actual and stable information
- Tools and workflows change faast
- Design rules don't change fast (if ever)
- Most parts of the PDK are long term stable



Submission process

Screenshot from the README TO_DEC2024:

Submission process

To submit for our OpenMPW run you have to have a valid github account. Make a fork of this repository and then create a separate directory for your design next to the ExampleDesign (you can also make a copy and rename it). Structure your data according to our recommendations, update the documentation and push your files to your fork, then make a pull request.

① Caution

On each PR a github action will be triggered to run a minimal DRC precheck (rejection test). Please consider it and do not upload many gds files.

Once you make a PR a github action will run a minimum set of DRC checks on each gds and gds.zip file. If the test passes it means that your design is manufacturable at our pilot line not ensuring the reliability. An example of a failure is shown on the following figure

Figure 1: Submission process



Physical constraints

Screenshot from the README TO_DEC2024:

Physical design constraint

- 1. Please align with the layout design rules which can be found here
- 2. The area granted to a community member is 2 mm^2 It includes the sealring.
- 3. The sealring can be found among KLayout PyCells.

Figure 2: Physical design constraints



Project structure

Screenshot from the README TO_DEC2024:

Directory structure

If you are a designer, we propose the following directory structure, which we and the community would appreciate you using. Please ensure that the design you submit is reproducible, meaning it should include all the information necessary to replicate the design.

```
| Mesign_name>
| Mesign_data
| L Motooll/format1/step1
| L data
| L Motooll/format2/setp2
| L data
| Modoc
| L Specification
| L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Specification | L Spec
```

The first segmentation separates the design data from a documentation and verification/validation data.

Figure 3: Directories in a project



Design data structure

Screenshot from the README TO_DEC2024:





DRC

During a submission to a Tapeout the design gets checked with a DRC via Github Actions.

Once you make a PR a github action will run a minimum set of DRC checks on each gds and gds.zip file. If the test passes it means that your design is manufacturable at our pilot line not ensuring the reliability. An example of a failure is shown on the following figure



The detailed report can be downloaded from a link, which can be found at the end of the section Details->Archive DRC Results as show on the image:





Figure 5: DRC via Github actions

Section 3

Read-the-docs



Read-the-docs

Open PDK Docu:

https://ihp-open-pdk-docs.readthedocs.io/en/latest/index.html

Open DesignLib Docu:

https://ihp-open-ip.readthedocs.io/en/latest/



README versus Read-the-docs

- The README version is a extract of the full documentation (read-the-docs) for the DesignLib.
- The read-the-docs version contains the Tapeout calender and further info



Tapeout calendar

Welcome to IHP-Open-DesignLib documentation!

IHP-Open-DesignLib is repository, which contains open source IC designs using IHP SG13G2 BiCMOS processs. It is also a central point for design fabrication under the concept of IHP Free MPW runs funded by a public German project FMD-QNC (16ME083). Project funds can be used exclusively to produce chip designs for non-commercial activities, such as university education, research projects, and others. In the project, a continuation for the provision of free area for the open source community is to be worked out.

Tape In date		10 May 2024		11 Nov 2024		22 Nov 2024		07 Apr 2025		09 May
Technology		SG13G2		SG13CMOS		SG13G2		SG13G2		SG13G2
Area available [mm²]		10		220		20		140		30
11 Nov 2024	22 Nov 2024		07 Apr 2025		09 May 2025		18 Jul 2025		15 Sep 2025	
SG13CMOS	SG13G2		SG13G2		SG13G2		SG13G2		SG13CMOS	
220	20		140		30		30		220	



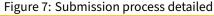
More submission information

development

The overview of the submission process is shown on the following figure. Submission Evaluation & Selection Sample Sharing your/IHP-Open IHP Open Chip IHP-GmbH/IHP-Final design Processing at DesignLib Open DesignLib locked IHP pilot line Depot Beginning of the Tape Out Date Production ends Ioint evaluation Submission date Automatic tests

The submission process contains a few steps, where some of them are mandatory and crucial:

 Project development phase. At the beginning specifications an criteria will be defined by PDK status, later specifications from sponsors might be possible



ends

Section 4

The last steps to a successful Tapeout



The last steps to a successful Tapeout

A few words about the finish of a Tapeout-ready GDS:

- A successfull Tapeout for a producable, correct and working micorchip contains more steps and knowdledge. It is out of scope of the course to explain and tutor these all details about this knowledge.
- Most of these steps will integrate into ORFS soon in a easy-to-use way eventually.



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Topic to watch in design

Till then, here is a (not complete) list of important topics:

- Placement and instanciation of the Input-Outputs.
- Metall fills
- Sealring construction
- Automated DRC free



Github Actions

• Tapeout Nov 2024 Actions drc.yml:

https://github.com/IHP-GmbH/TO_Nov2024/blob/main/.github/workflows/drc.yml

• Tapeout Nov 2024 Actions runs:

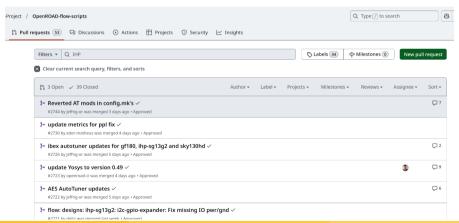
https://github.com/IHP-GmbH/TO_Nov2024/actions



Active development in ORFS

Pull requests in ORFS with the search IHP in it:

https://github.com/The-OpenROAD-Project/OpenROAD-flow-scripts/pulls?q=IHP+





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Issues in ORFS (open and IHP in it):

https://github.com/The-OpenROAD-Project/OpenROAD-flow-scripts/issues?q=is%3Aissue%20state%3Aopen%20IHP

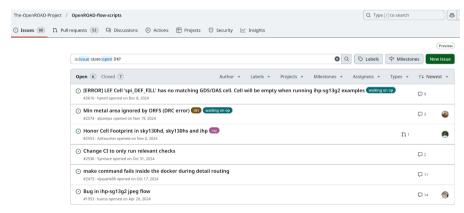


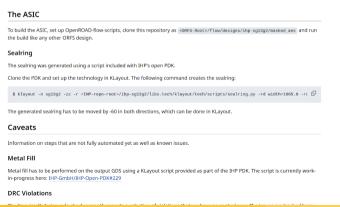
Figure 9: ORFS issues, open and IHP in it



Workarounds (example masked_aes)

The README of the design example from earlier (masked_aes) gives some basic, but sufficient information about the actual state and the workarounds.

https://github.com/HEP-Alliance/masked-aes-tapeout/blob/main/README.md



Before your Tapeout

If you plan to do a Tapeout with open-source to a Shuttlerun at IHP:

- Get in touch with the people at IHP before submitting a GDS.
- Inform yourself about the actual changes in the tools, the PDK and the submission repositories.
- Look for recent examples from the CoreExpert Group.



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Non public and non open-source designs

IMPORTANT NOTICE:

• Using open-source doesn't mean you have to publish your work in open-source!

With using the open-source EDA tools and the open-source IHP PDK it is possible

- to design and fabricate closed source microchips at IHP.
- to not make a design public.

If you plan to do this: Talk to IHP!



Section 5

Contribute to open-source



Contributing with Git

If you waant to start contributing to open-source (maybe to this course?):

- Create a Git account
- Join a discussion about an issue.
- When you discover an error, writ4e an issue yourself.

It is really not much more then a ticket-system vi email.



The Feedback to this course

Your feedback will become issues in the course repository. Join in the discussion if you want to contribute:

https://github.com/OS-EDA/Course/issues?q=is%3Aissue

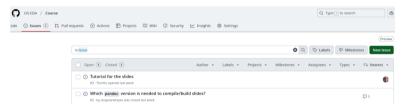


Figure 11: Issue tracking in the course repository

